

# ST13007D

# HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- IMPROVED SPECIFICATION:
  - LOWER LEAKAGE CURRENT
  - TIGHTER GAIN RANGE
  - DC CURRENT GAIN PRESELECTION
  - TIGHTER STORAGE TIME RANGE
- HIGH VOLTAGE CAPABILITY
- INTEGRATED FREE-WHEELING DIODE
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- FULLY CHARACTERIZED AT 125 °C
- LARGE RBSOA

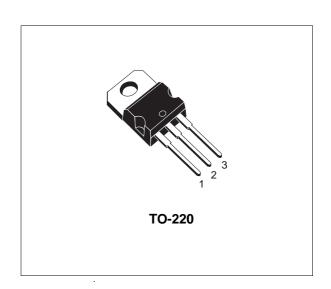
#### **APPLICATIONS**

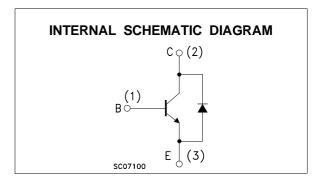
- UP TO 120W ELECTRONIC TRANSFORMERS FOR HALOGEN LAMPS
- SWITCH MODE POWER SUPPLIES



The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and high voltage capability.

It uses a Cellular Emitter structure to enhance switching speeds.





#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{CEV}$	Collector-Emitter Voltage (V <sub>BE</sub> = -1.5V)	700	V
$V_{CEO}$	Collector-Emitter Voltage (I <sub>B</sub> = 0)	400	V
$V_{EBO}$	Emitter-Base Voltage (I <sub>C</sub> = 0)	9	V
Ic	Collector Current	8	Α
I <sub>CM</sub>	Collector Peak Current	16	Α
lΒ	Base Current	4	Α
$I_{BM}$	Base Peak Current	8	Α
P <sub>tot</sub>	Total Dissipation at T <sub>c</sub> ≤ 25 °C	80	W
$T_{stg}$	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

April 2003 1/7

#### THERMAL DATA

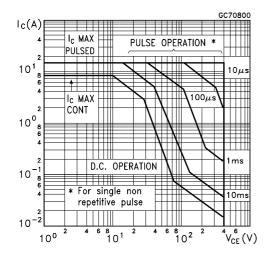
R <sub>thj-case</sub>	Thermal Resistance Junction-case	Max	1.56	°C/W
Rthj-amb	Thermal Resistance Junction-ambient	Max	62.5	°C/W

## **ELECTRICAL CHARACTERISTICS** (T<sub>case</sub> = 25 °C unless otherwise specified)

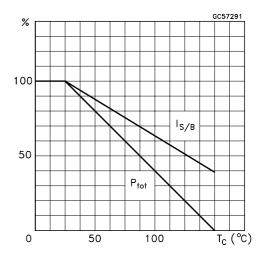
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector Cut-off Current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 700 V V <sub>CE</sub> = 700 V			10 0.5	μA mA
ICEO	Collector Cut-off Current (I <sub>B</sub> = 0)	V <sub>CE</sub> = 400 V			100	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current (I <sub>C</sub> = 0)	V <sub>EB</sub> = 9 V			100	μΑ
V <sub>CEO(sus)*</sub>	Collector-Emitter Sustaining Voltage (I <sub>B</sub> = 0)	I <sub>C</sub> = 10 mA	400			V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage	$\begin{split} I_C &= 2 \ A & I_B &= 0.4 \ A \\ I_C &= 5 \ A & I_B &= 1 \ A \\ I_C &= 8 \ A & I_B &= 2 \ A \\ I_C &= 5 \ A & I_B &= 1 \ A & T_c &= 100 \ ^{\circ}C \end{split}$			0.8 1.5 2 3	> > > >
V <sub>BE(sat)</sub> *	Base-Emitter Saturation Voltage	$ \begin{aligned} &I_C = 2 \ A & &I_B = 0.4 \ A \\ &I_C = 5 \ A & &I_B = 1 \ A \\ &I_C = 5 \ A & &I_B = 1 \ A & &T_c = 100 \ ^oC \end{aligned} $			1.2 1.6 1.5	<<<
h <sub>FE</sub> *	DC Current Gain	I <sub>C</sub> = 2 A	18 8		40 25	
V <sub>f</sub>	Diode Forward Voltage	I <sub>C</sub> = 3 A			2.5	V
t <sub>s</sub>	INDUCTIVE LOAD Storage Time Fall Time	$I_{C} = 5 \text{ A}$ $V_{CL} = 250 \text{ V R}_{BB} = 0\Omega$ $I_{B1} = 1 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$ $L = 200 \mu\text{H}$ (see figure 1)		1.7 90	2.3 150	μs ns
t <sub>s</sub>	INDUCTIVE LOAD Storage Time Fall Time	$\begin{array}{llllllllllllllllllllllllllllllllllll$		2.2 150		μs ns

<sup>\*</sup> Pulsed: Pulse duration = 300 μs, duty cycle 2 %.

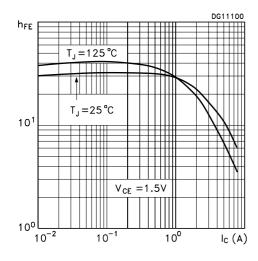
#### Safe Operating Area



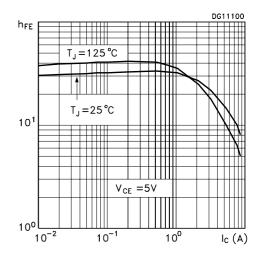
#### **Derating Curve**



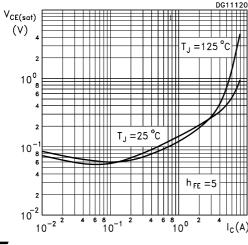
DC Current Gain



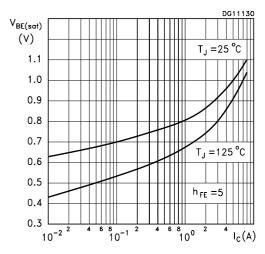
DC Current Gain



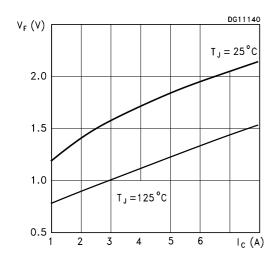
Collector Emitter Saturation Voltage



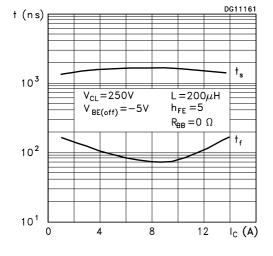
Base Emitter Saturation Voltage



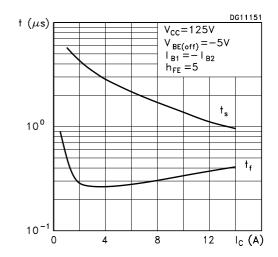
#### Diode Forward Voltage



## Switching Time Inductive Load



### Switching Time Resistive Load



#### Reverse Biased SOA

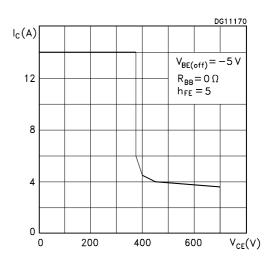


Figure 1: Inductive Load Switching Test Circuit.

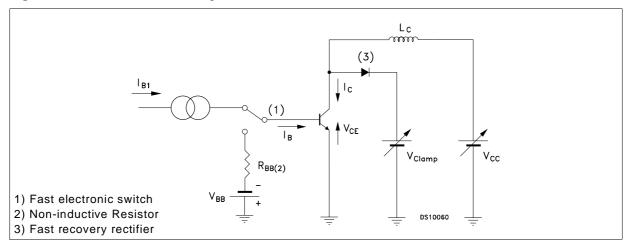
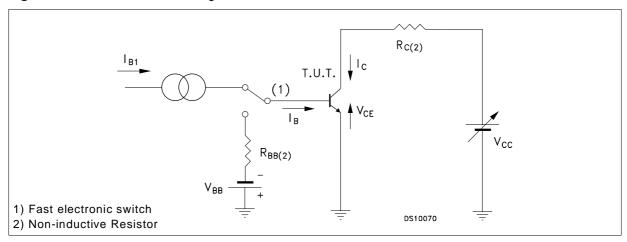
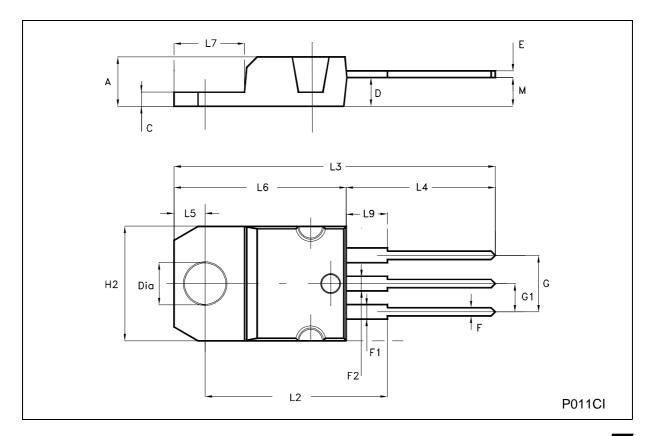


Figure 2: Resistive Load Switching Test Circuit.



## **TO-220 MECHANICAL DATA**

DIM.	mm		inch			
DIWI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	4.40		4.60	0.173		0.181
С	1.23		1.32	0.048		0.052
D	2.40		2.72	0.094		0.107
Е	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.202
G1	2.40		2.70	0.094		0.106
H2	10.00		10.40	0.394		0.409
L2		16.40			0.645	
L4	13.00		14.00	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.20		6.60	0.244		0.260
L9	3.50		3.93	0.137		0.154
М		2.60			0.102	
DIA.	3.75		3.85	0.147		0.151



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